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SEMICONDUCTOR



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Product data sheet



SOD-523



ZENER DIODE

FEATURES

- Planar Die Construction
- 150mW Power Dissipation
- Zener Voltages from 2.4 – 43V

MAXIMUM RATINGS($T_a=25^{\circ}\text{C}$ unless otherwise specified)

| Characteristic | Symbol | Value | Unit |
|---|-----------------|----------|------|
| Forward Voltage @ $I_F=10\text{mA}$ | V_F | 0.9 | V |
| Power Dissipation | P_D | 150 | mW |
| Thermal Resistance from Junction to Ambient | $R_{\theta JA}$ | 833 | /W |
| Junction Temperature | T_j | 150 | |
| Storage Temperature | T_{stg} | -55~+150 | |

ELECTRICAL CHARACTERISTICS
T_a=25°C unless otherwise specified

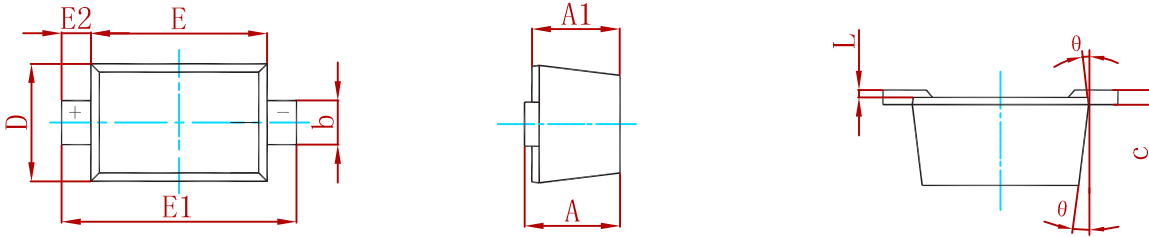
| Type Number | Type Code | Zener Voltage Range (Note 2) | | | | Maximum Zener Impedance (Note 3) | | | Maximum Reverse Current | | Typical temperature coefficient @ I _{ZT} mV/°C | |
|-------------|-----------|---------------------------------|--------|--------|-----------------|----------------------------------|----------------------------------|------|-------------------------|----------------|---|------|
| | | V _Z @I _{ZT} | | | I _{ZT} | Z _{ZT} @I _{ZT} | Z _{ZK} @I _{ZK} | | I _R | V _R | Min | Max |
| | | Nom(V) | Min(V) | Max(V) | (mA) | (Ω) | (mA) | (μA) | (V) | | | |
| BZX584C2V4 | Z11 | 2.4 | 2.20 | 2.60 | 5 | 100 | 600 | 1.0 | 50 | 1.0 | -3.5 | 0 |
| BZX584C2V7 | Z12 | 2.7 | 2.5 | 2.9 | 5 | 100 | 600 | 1.0 | 20 | 1.0 | -3.5 | 0 |
| BZX584C3V0 | Z13 | 3.0 | 2.8 | 3.2 | 5 | 95 | 600 | 1.0 | 10 | 1.0 | -3.5 | 0 |
| BZX584C3V3 | Z14 | 3.3 | 3.1 | 3.5 | 5 | 95 | 600 | 1.0 | 5 | 1.0 | -3.5 | 0 |
| BZX584C3V6 | Z15 | 3.6 | 3.4 | 3.8 | 5 | 90 | 600 | 1.0 | 5 | 1.0 | -3.5 | 0 |
| BZX584C3V9 | Z16 | 3.9 | 3.7 | 4.1 | 5 | 90 | 600 | 1.0 | 3 | 1.0 | -3.5 | 0 |
| BZX584C4V3 | Z17 | 4.3 | 4.0 | 4.6 | 5 | 90 | 600 | 1.0 | 3 | 1.0 | -3.5 | 0 |
| BZX584C4V7 | Z1 | 4.7 | 4.4 | 5.0 | 5 | 80 | 500 | 1.0 | 3 | 2.0 | -3.5 | 0.2 |
| BZX584C5V1 | Z2 | 5.1 | 4.8 | 5.4 | 5 | 60 | 480 | 1.0 | 2 | 2.0 | -2.7 | 1.2 |
| BZX584C5V6 | Z3 | 5.6 | 5.2 | 6.0 | 5 | 40 | 400 | 1.0 | 1 | 2.0 | -2.0 | 2.5 |
| BZX584C6V2 | Z4 | 6.2 | 5.8 | 6.6 | 5 | 10 | 150 | 1.0 | 3 | 4.0 | 0.4 | 3.7 |
| BZX584C6V8 | Z5 | 6.8 | 6.4 | 7.2 | 5 | 15 | 80 | 1.0 | 2 | 4.0 | 1.2 | 4.5 |
| BZX584C7V5 | Z6 | 7.5 | 7.0 | 7.9 | 5 | 15 | 80 | 1.0 | 1 | 5.0 | 2.5 | 5.3 |
| BZX584C8V2 | Z7 | 8.2 | 7.7 | 8.7 | 5 | 15 | 80 | 1.0 | 0.7 | 5.0 | 3.2 | 6.2 |
| BZX584C9V1 | Z8 | 9.1 | 8.5 | 9.6 | 5 | 15 | 100 | 1.0 | 0.5 | 6.0 | 3.8 | 7.0 |
| BZX584C10 | Z9 | 10 | 9.4 | 10.6 | 5 | 20 | 150 | 1.0 | 0.2 | 7.0 | 4.5 | 8.0 |
| BZX584C11 | Y1 | 11 | 10.4 | 11.6 | 5 | 20 | 150 | 1.0 | 0.1 | 8.0 | 5.4 | 9.0 |
| BZX584C12 | Y2 | 12 | 11.4 | 12.7 | 5 | 25 | 150 | 1.0 | 0.1 | 8.0 | 6.0 | 10.0 |
| BZX584C13 | Y3 | 13 | 12.4 | 14.1 | 5 | 30 | 170 | 1.0 | 0.1 | 8.0 | 7.0 | 11.0 |
| BZX584C15 | Y4 | 15 | 13.8 | 15.6 | 5 | 30 | 200 | 1.0 | 0.1 | 10.5 | 9.2 | 13.0 |
| BZX584C16 | Y5 | 16 | 15.3 | 17.1 | 5 | 40 | 200 | 1.0 | 0.1 | 11.2 | 10.4 | 14.0 |
| BZX584C18 | Y6 | 18 | 16.8 | 19.1 | 5 | 45 | 225 | 1.0 | 0.1 | 12.6 | 12.4 | 16.0 |
| BZX584C20 | Y7 | 20 | 18.8 | 21.2 | 5 | 55 | 225 | 1.0 | 0.1 | 14.0 | 14.4 | 18.0 |
| BZX584C22 | Y8 | 22 | 20.8 | 23.3 | 5 | 55 | 250 | 1.0 | 0.1 | 15.4 | 16.4 | 20.0 |
| BZX584C24 | Y9 | 24 | 22.8 | 25.6 | 5 | 70 | 250 | 1.0 | 0.1 | 16.8 | 18.4 | 22.0 |
| BZX584C27 | Y10 | 27 | 25.1 | 28.9 | 2 | 80 | 300 | 0.5 | 0.1 | 18.9 | 21.4 | 25.3 |
| BZX584C30 | Y11 | 30 | 28.0 | 32.0 | 2 | 80 | 300 | 0.5 | 0.1 | 21.0 | 24.4 | 29.4 |
| BZX584C33 | Y12 | 33 | 31.0 | 35.0 | 2 | 80 | 325 | 0.5 | 0.1 | 23.1 | 27.4 | 33.4 |
| BZX584C36 | Y13 | 36 | 34.0 | 38.0 | 2 | 90 | 350 | 0.5 | 0.1 | 25.2 | 30.4 | 37.4 |
| BZX584C39 | Y14 | 39 | 37.0 | 41.0 | 2 | 130 | 350 | 0.5 | 0.1 | 27.3 | 33.4 | 41.2 |
| BZX584C43 | Y15 | 43 | 40.0 | 46.0 | 2 | 100 | 700 | 1 | 0.1 | 32 | 10 | 12 |

Notes: 1. Valid provided that device terminals are kept at ambient temperature.

2. Tested with pulses, period=5ms,pulse width =300μs.

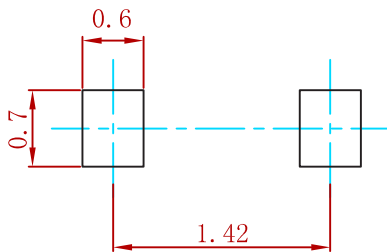
3. f = 1 kHz.

PACKAGE MECHANICAL DATA



| Symbol | Dimensions In Millimeters | | Dimensions In Inches | |
|--------|---------------------------|-------|----------------------|-------|
| | Min | Max | Min | Max |
| A | 0.510 | 0.770 | 0.020 | 0.031 |
| A1 | 0.500 | 0.700 | 0.020 | 0.028 |
| b | 0.250 | 0.350 | 0.010 | 0.014 |
| c | 0.080 | 0.150 | 0.003 | 0.006 |
| D | 0.750 | 0.850 | 0.030 | 0.033 |
| E | 1.100 | 1.300 | 0.043 | 0.051 |
| E1 | 1.500 | 1.700 | 0.059 | 0.067 |
| E2 | 0.200 REF | | 0.008 REF | |
| L | 0.010 | 0.070 | 0.001 | 0.003 |
| θ | 7° REF | | 7° REF | |

Suggested Pad Layout



- Note:
1. Controlling dimension: in millimeters.
 2. General tolerance: $\pm 0.05\text{mm}$.
 3. The pad layout is for reference purposes only.

REEL SPECIFICATION

| P/N | PKG | QTY |
|----------------------|---------|------|
| BZX584C2V4-BZX584C43 | SOD-523 | 3000 |

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